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# IPC-MS-810

## Guidelines for High Volume Microsection

### **IPC-MS-810**

Original Publication -  
October 1993

A standard developed by IPC

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In May 1995 the IPC's Technical Activities Executive Committee adopted Principles of Standardization as a guiding principle of IPC's standardization efforts.

**Standards Should:**

- Show relationship to Design for Manufacturability (DFM) and Design for the Environment (DFE)
- Minimize time to market
- Contain simple (simplified) language
- Just include spec information
- Focus on end product performance
- Include a feedback system on use and problems for future improvement

**Standards Should Not:**

- Inhibit innovation
- Increase time-to-market
- Keep people out
- Increase cycle time
- Tell you how to make something
- Contain anything that cannot be defended with data

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Adopted October 6, 1998

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# **Guidelines for High Volume Microsection**

Developed by the Automatic Microsectioning Task Group (7-10b)  
of the Testing Committee (7-10) of IPC

Users of this standard are encouraged to participate in the  
development of future revisions.

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## Acknowledgment

Any Standard involving a complex technology draws material from a vast number of sources. While the principal members of the IPC Automatic Microsectioning Task Group of the IPC Testing Committee are shown below, it is not possible to include all of those who assisted in the evolution of this standard. To each of them, the members of the IPC extend their gratitude.

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